Editorial

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Biographical notes: Zheng Xu is currently a Professor at Shanghai Polytechnic University, China. He is with over 4000 citations (H-index 31). He has authored or co-authored more than 200 publications. He is also an associate editor of Springer DIoT journal. He won the Best Editor Award of the Year 2022 of Springer journal *Discover Internet of Things*. His paper titled 'Ensemble-based multi-filter feature selection method for DDoS detection in cloud computing' obtained EURASIP Best Paper Awards 2019.

Jemal H. Abawajy is a Professor at the School of Information Technology, Deakin University, Australia. He is currently the Director of the Parallel and Distributing Computing Laboratory. He is a senior member of the IEEE Technical Committee on Scalable Computing, the IEEE Technical Committee on Dependable Computing and Fault Tolerance, and the IEEE Communication Society. His leadership is extensive, spanning industrial, academic, and professional areas.

This special issue focuses on the sustainable issues of design and manufacturing and attempts to establish a review combining design and manufacturing sustainability. The objective of this special issue is to provide a comprehensive platform for researchers, scientists, engineers, and practitioners to share their insights, exchange knowledge, and present cutting-edge solutions to address sustainability challenges. This issue includes four papers as part 2.

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